





PCB Number: PWR664  
PCB Rev: A

PCB LOGO  
Texas Instruments

PCB LOGO  
FCC disclaimer

PCB LOGO  
Pb-Free Symbol

PCB LOGO  
ESD Susceptible

LRL 1  
PCB Label  
Size: 0.65" x 0.20"

Label Table	
Variant	Label Text
001	bq25890EVM-664
002	bq25892EVM-664
003	bq25895EVM-664

ZZ1  
Label Assembly Note  
This Assembly Note is for PCB labels only



ZZ2  
Assembly Note  
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3  
Assembly Note  
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4  
Assembly Note  
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

TIDA-00589

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		Project Title: TIDA-00589 - 5A Charger 3.1A Power Bank	Sheet Title:	Project Title: TIDA-00589 - 5A Charger 3.1A Power Bank	
		Assembly Variant: 003	Sheet: 1 of 1		
		File: PWR664RevA_Hardware_ANSI-B_SchDoc	Size: B		
		Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>			



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